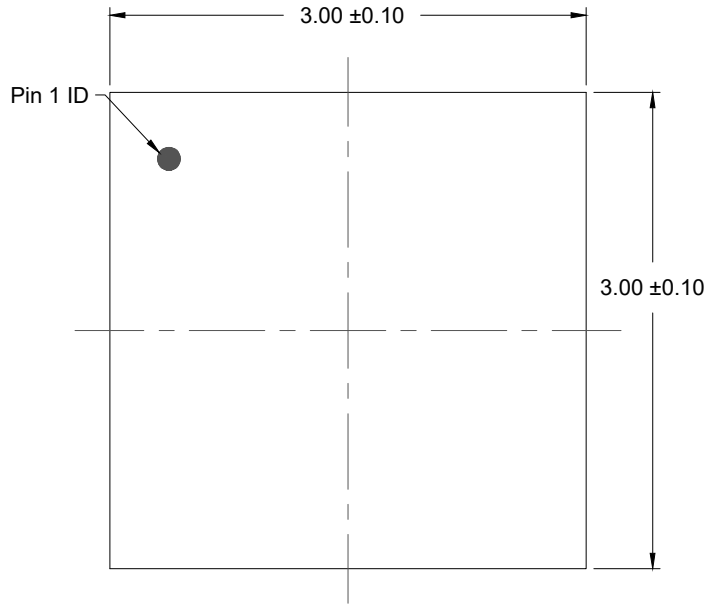
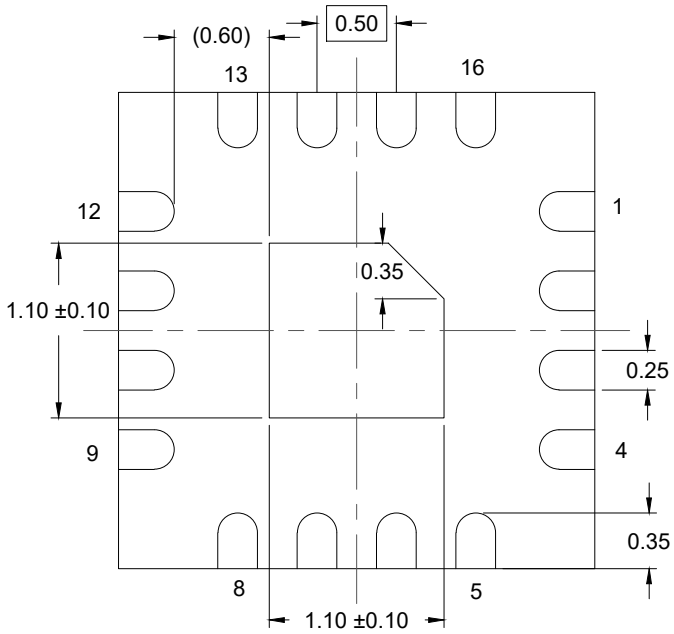
Package Outline Drawing

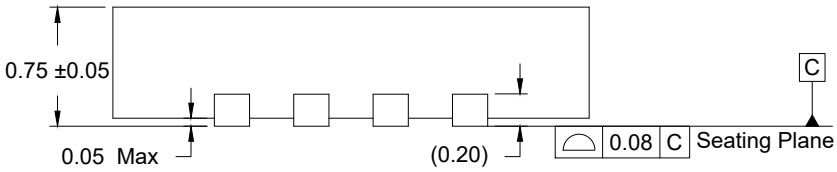
Package Code: NTG16P1
16-VFQFPN 3.0 x 3.0 x 0.75 mm Body, 0.5mm Pitch
PSC-4296-01, Revision: 01, Date Created: Feb 26, 2024



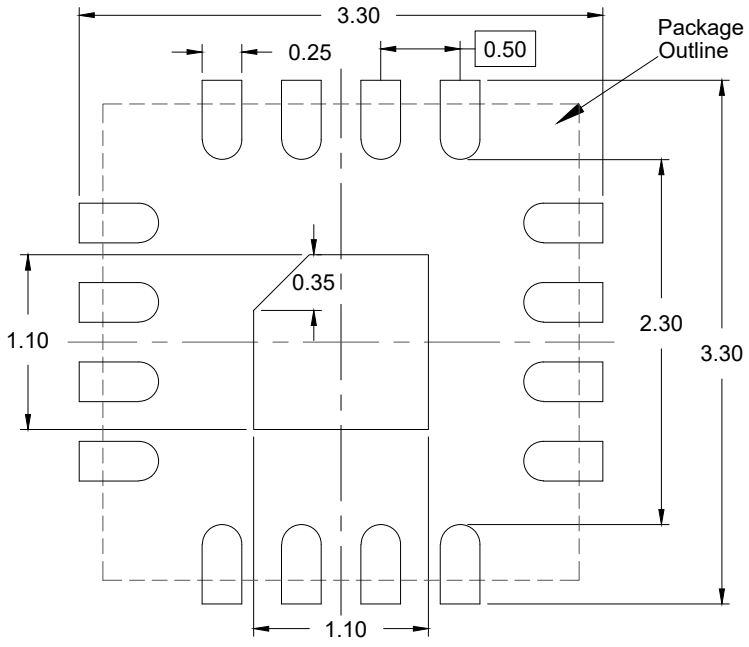
TOP VIEW



BOTTOM VIEW



SIDE VIEW



RECOMMENDED LAND PATTERN
(PCB Top View, NSMD Design)

NOTES:

1. JEDEC compatible.
2. All dimensions are in mm and angles are in degrees.
3. Use ±0.05 mm for the non-toleranced dimensions.
4. Numbers in ( ) are for references only.

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